								ſ	English		~		Sear	earch Microchip			
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PRODUCTS APP	PLICATIONS DESIG	N SUF	PPOR	Г	TRAII	NING	SA	MPLE	& BUY	AE	OUT	US	Con	tact Us	myl	Nicrocl	nip Log
Product Change	Notification - JAON	-080	JZL2	83	(Print	er Frie	ndly)										
Date:	13 Jan 2016																
Notification subject:	CCB 1834 Initial Notice SPDIP, 18L and 20L PI							ected pro	ducts of t	he 0.25ı	IM TSN	IC wafe	er techi	nology	availat	ole in 28	3L
Notification text:	PCN Status: Initial notification																
	Microchip Parts Affe		ts foun	d in th	ne atta	chmen	its field	l below l	abeled a	s PCN	_#_Affe	ected_	CPN.				
	NOTE: For your conv	enienc	e Micro	ochip	includ	es ider	ntical f	les in tw	o forma	s (.pdf	and .xl	s).					
	Description of Char Qualification of pallac technology available	lium co										roduc	is of th	ie 0.25	ium T	SMC w	/afer
	<b>Pre Change:</b> Gold (Au) or Palladiu	m coat	ed cop	per w	ire (Pd	Cu) bo	ond wi	re									
	Post Change: Palladium coated cop	Post Change: Palladium coated copper with gold flash (CuPdAu) bond wire															
	Pre and Post Chang	e Sum	mary:														
							Pre Change					Post Change					
	Asser	Assembly Site					MMT assembly site					MMT assembly site					
	Wire	Wire material					Au wire or PdCu wire					CuPdAu wire					
	Die atta	Die attach material					CRM-1064L					CRM-1064L					
	Molding com	Molding compound material					GE800					GE800					
	Lead fra	Lead frame material					CDA194					CDA194					
	Impacts to Data She None	et:															
	Reason for Change To improve manufact		y by qı	ıalifyiı	ng Pall	adium	coate	d coppe	with go	ld flash	(CuPc	IAu) b	ond wi	re.			
	Change Implementa In Progress	Change Implementation Status: In Progress															
		Estimated First Ship Date: April 20, 2016 (date code: 1616)															
	NOTE: Please be ad	vised t	hat afte	er the	estima	ated fir	st ship	date cu	stomers	may re	ceive	ore an	d post	chang	je par	ts.	
	Summary Table:	Summary Table:															
		January 2016			6	February 2016				March 2016			Ар			oril 2016	
	WW	01	02	03	04	05	06	07	08 09	10	11	12	13	14	15	16	17
	Initial PCN Issue Date		X				L										

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Qual Report

Implementation

Markings to Distinguish Revised from Unrevised Devices: Traceability code

Availability Final PCN Issue

Date

Date

Revision History: January 13, 2016: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN\_JAON-08OJZL283\_Qual\_Plan.pdf PCN\_JAON-08OJZL283\_Affected\_CPN.pdf PCN\_JAON-08OJZL283\_Affected\_CPN.xls

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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